

# **FMV11N60E**

#### **FUJI POWER MOSFET**

## Super FAP-E<sup>3</sup> series

### **N-CHANNEL SILICON POWER MOSFET**

#### Features

Maintains both low power loss and low noise Lower R<sub>DS</sub>(on) characteristic More controllable switching dv/dt by gate resistance Smaller V<sub>GS</sub> ringing waveform during switching

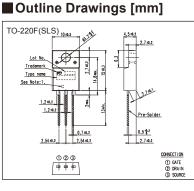
Narrow band of the gate threshold voltage (3.0±0.5V) High avalanche durability

#### Applications

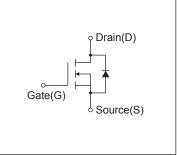
Switching regulators UPS (Uninterruptible Power Supply) **DC-DC** converters

#### Maximum Ratings and Characteristics

#### Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)



Equivalent circuit schematic



Description	Symbol	Characteristics	Unit	Remarks	
	VDS	600	V		
Drain-Source Voltage	VDSX	600	V	V <sub>GS</sub> = -30V	
Continuous Drain Current	lo	±11	A		
Pulsed Drain Current	Idp	±44	A		
Gate-Source Voltage	Vgs	±30	V		
Repetitive and Non-Repetitive Maximum AvalancheCurrent	lar	11	А	Note*1	
Non-Repetitive Maximum Avalanche Energy	Eas	384	mJ	Note*2	
Repetitive Maximum Avalanche Energy	Ear	6.5	mJ	Note*3	
Peak Diode Recovery dV/dt	dV/dt	4.9	kV/µs	Note*4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5	
Maulaum Damas Disaination	PD	2.16	W	Ta=25°C	
Maximum Power Dissipation		65	vv	Tc=25°C	
Operating and Starage Temperature range	Tch	150	°C		
Operating and Storage Temperature range	Tstg	-55 to + 150	°C		

#### • Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BVDSS	ID=250µA, VGS=0V		600	-	-	V
Gate Threshold Voltage	V <sub>GS</sub> (th)	ID=250µA, VDS=VGS		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current		V <sub>DS</sub> =600V, V <sub>GS</sub> =0V	Tch=25°C	-	-	25	μA
	IDSS	V <sub>DS</sub> =480V, V <sub>GS</sub> =0V	Tch=125°C	-	-	250	
Gate-Source Leakage Current	Igss	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V		-	10	100	nA
Drain-Source On-State Resistance	RDS (on)	ID=5.5A, VGS=10V		-	0.641	0.75	Ω
Forward Transconductance	<b>g</b> fs	ID=5.5A, VDS=25V		6	12	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =25V V <sub>GS</sub> =0V f=1MHz		-	1700	2550	pF
Output Capacitance	Coss			-	150	225	
Reverse Transfer Capacitance	Crss			-	11	16.5	
Turn-On Time	td(on)	V <sub>cc</sub> =300V V <sub>GS</sub> =10V I <sub>D</sub> =5.5A R <sub>G</sub> =15Ω		-	21	31.5	ns
	tr			-	9.5	14.5	
Turn-Off Time	td(off)			-	100	150	
	tf			-	19	28.5	
Total Gate Charge	QG	Vcc=300V I₀=11A Vcs=10V		-	48.5	73	nC
Gate-Source Charge	QGS			-	12.5	19	
Gate-Drain Charge	QGD			-	14	21	
Avalanche Capability	lav	L=2.64mH, Tch=25°C		11	-	-	A
Diode Forward On-Voltage	Vsd	IF=11A, VGS=0V, Tch=25°C		-	0.86	1.30	V
Reverse Recovery Time	trr	I⊧=11A, V₀s=0V -di/dt=100A/µs, Tch=25°C		-	0.52	-	μS
Reverse Recovery Charge	Qrr			-	5.5	-	μC

#### Thermal Characteristics

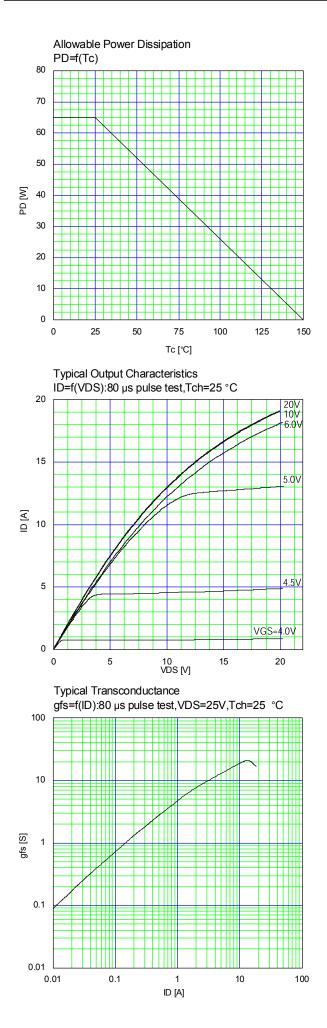
Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to Case			1.920	°C/W
	Rth (ch-a)	Channel to Ambient			58.0	°C/W

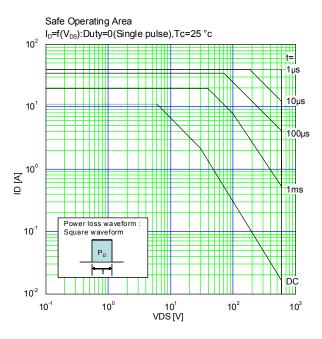
Note \*1 : Tch≤150°C

Note 1 : Italia 50 C, IAs=5A, L=28.2mH, Vcc=60V, R<sub>G</sub>=50Ω EAs limited by maximum channel temperature and avalanche current. See to 'Avalanche Energy' graph.

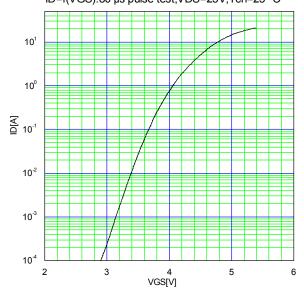
Note \*3 : Repetitive rating : Pulse width limited by maximum channel temperature.

See to the 'Transient Themal impeadance' graph. Note \*4 : IF≤-ID, -di/dt=100A/µs, Vcc≤BVoss, Tch≤150°C. Note \*5 : IF≤-ID, dv/dt=4.4kV/µs, Vcc≤BVoss, Tch≤150°C.

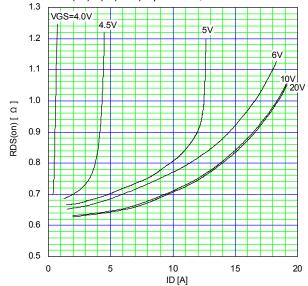


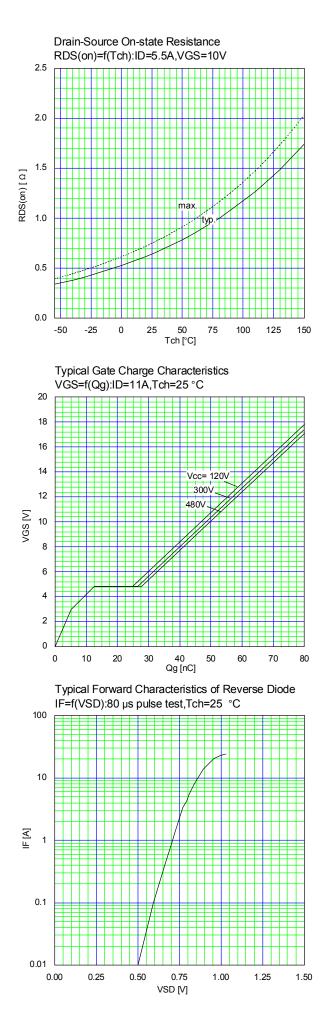


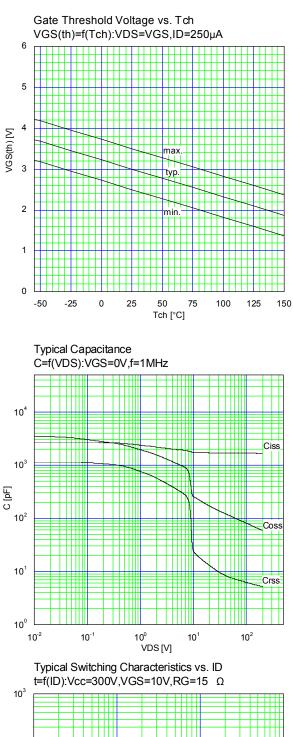
Typical Transfer Characteristic ID=f(VGS):80 µs pulse test,VDS=25V,Tch=25 °C

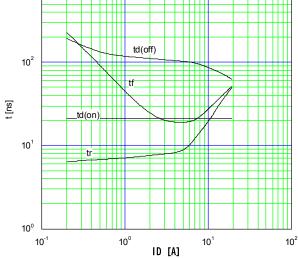


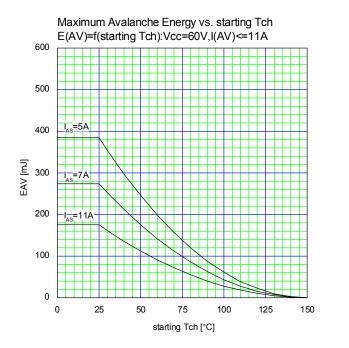
Typical Drain-Source on-state Resistance RDS(on)=f(ID):80 µs pulse test,Tch=25 °C

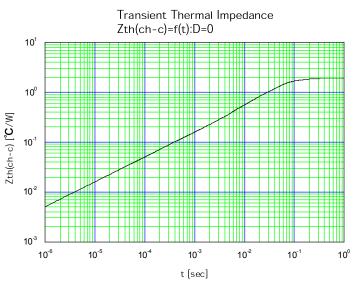












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